

## DATA vs TIME

### Look at Trend versus Time

Trend Chart

### Model Distribution vs Time

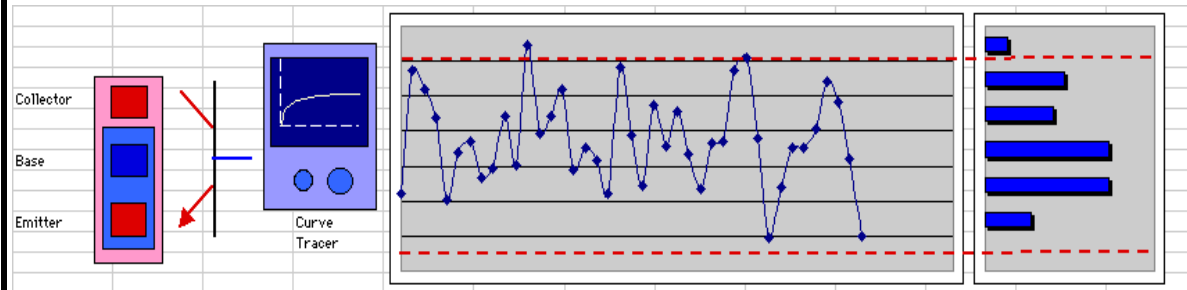
Time Series Modeling  
Autocorrelation  
Partial Autocorrelation  
Moving Average  
EWMA  
AR  
MA  
ARIMA

### Study Sources -Time Variation

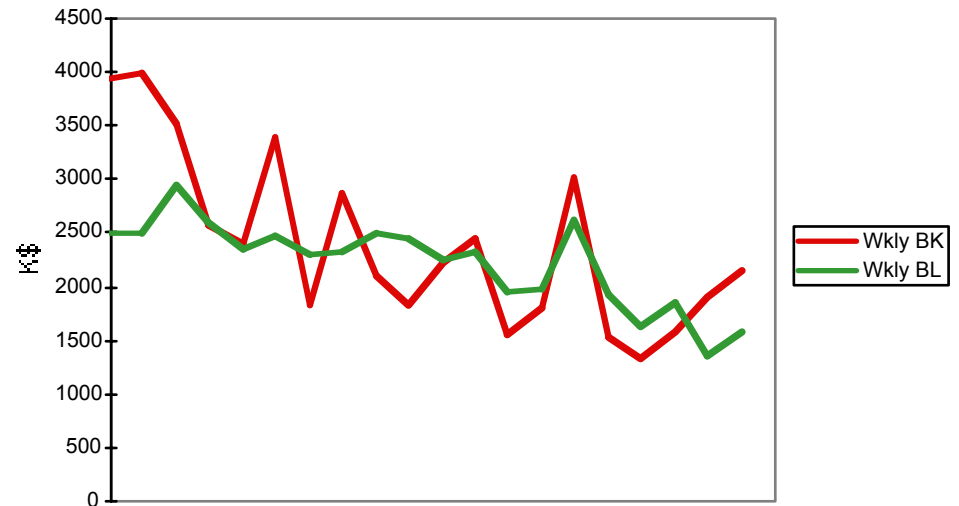
Gauge Capability  
Variance Components Analysis

### Compare Trend to Limits

Control Charts  
X-Bar  
R, S  
Individuals  
Moving R  
EWMA



### Weekly Bookings and Billings



# Open a New Worksheet / Type: Excel or Copy from Excel (stockprices.xls)

Microsoft Excel - stockprices.xls

Paste All Items

File Edit View Insert Format Tools Data Window Help Acrobat

Geneva 9 B I U

E68 = 27.31

	A	B	C	D	E	F	G	H	I	J	K	L
1												
2		Mot	ONNN	Lucent	Dow							
3	Aug-15-02	12.3	2	1.5	29.84							
4	Aug-16-02	12.9	1.93	1.47	29.51							
5	Aug-19-02	13.38	2.08	1.45	29.16							
6	Aug-20-02	12.67	2.25	1.45	29.66							
7	Aug-21-02	13.38	2.14	1.43	28.74							
8	Aug-22-02	13.53	2.25	1.47	29.18							
9	Aug-23-02	13	2.2	1.58	29.71							
10	Aug-26-02	13	2.08	1.5	29.15							
11	Aug-27-02	12.78	2.16	1.87	29.75							
12	Aug-28-02	12.1	1.94	1.89	30.02							
13	Aug-29-02	12.31	1.94	1.69	29.26							
14	Aug-30-02	12	1.98	1.82	29.87							
15	Nov-01-02	9.42	1.43	1.14	26.48							
16	Nov-04-02	9.98	1.43	1.18	26							
17	Nov-05-02	9.85	1.52	1.22	26.41							
18	Nov-06-02	9.62	1.58	1.32	27.7							
19	Nov-07-02	9.02	1.53	1.22	26.5							
20	Nov-08-02	8.8	1.59	1.21	26.53							
21	Nov-11-02	8.38	1.5	1.08	25.47							
22	Nov-12-02	8.75	1.59	1.12	26.16							
23	Nov-13-02	8.75	1.54	1.11	26.5							
24	Nov-14-02	9.07	1.65	1.18	27.85							
25	Oct-01-02	10.48	1.13	0.76	29.8							
26	Oct-02-02	10.15	1.14	0.79	27.25							
27	Oct-03-02	10.46	1.07	0.75	26.69							
28	Oct-04-02	10.01	0.91	0.75	26.23							
29	Oct-07-02	9.5	0.96	0.7	25.45							
30	Oct-08-02	9.75	1	0.69	25.92							
31	Oct-09-02	8.3	1.12	0.67	24.5							
32	Oct-10-02	9.09	1.26	0.7	25.15							
33	Oct-11-02	9.97	1.31	0.58	26.77							
34	Oct-14-02	10.1	1.09	0.69	26.76							

Sheet1 Sheet2 Sheet3

Select destination and press ENTER or choose Paste

Sum=2694.94

# Paste into Minitab

MINITAB - Untitled

File Edit Manip Calc Stat Graph Editor Window Help

Session

11/15/2002 5:42:29 AM

Welcome to Minitab, press F1 for help.

Worksheet 1 \*\*\*

	C1-T	C2	C3	C4	C5	C6	C7	C8	C9	C10	C11	C12	C13	C14	C15	C16
	Date	Mot	ONNN	Lucent	Dow											
1	Aug-15-02	12.30	2.00	1.50	29.84											
2	Aug-16-02	12.90	1.93	1.47	29.51											
3	Aug-19-02	13.38	2.08	1.45	29.16											
4	Aug-20-02	12.67	2.25	1.45	29.66											
5	Aug-21-02	13.38	2.14	1.43	28.74											
6	Aug-22-02	13.53	2.25	1.47	29.18											
7	Aug-23-02	13.00	2.20	1.58	29.71											
8	Aug-26-02	13.00	2.08	1.50	29.15											
9	Aug-27-02	12.78	2.16	1.87	29.75											

Project Man...

Current Worksheet: Worksheet 1

5:42 AM

- Stat
- Graph
- Editor
- Window
- Basic Statistics
- Regression
- ANOVA
- DOE
- Control Charts
- Quality Tools
- Reliability/Survival
- Multivariate
- Time Series**
- Tables
- Nonparametrics
- EDA
- Power and Sample Size

# Trend Chart

Time Series Plot...

Trend Analysis...

Decomposition...

Moving Average...

- OR -

- Graph
- Editor
- Window
- Layout...
- Plot...
- Time Series Plot...**
- Chart...
- Histogram...
- Boxplot...
- Matrix Plot...
- Draftsman Plot...
- Contour Plot...
- 3D Plot...
- 3D Wireframe Plot...
- 3D Surface Plot...
- Dotplot...
- Pie Chart...
- Marginal Plot...
- Probability Plot...
- Stem-and-Leaf...
- Character Graphs

## Time Series Plot

	C2	Mot
C3	ONNN	
C4	Lucent	
C5	Dow	

**Graph variables:**

**Graph**

	Y
1	Mot
2	
3	

**Time Scale**

☒ Index

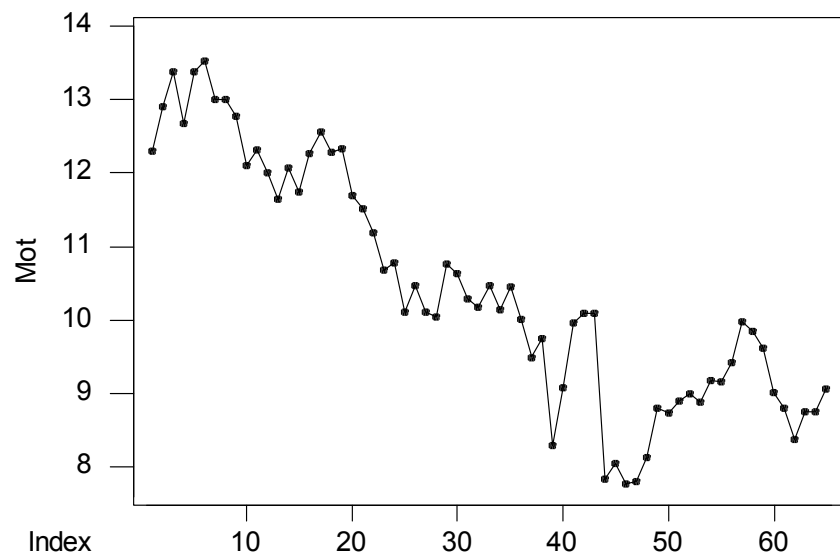
☐ Date/Time Stamp:

☐ Calendar:

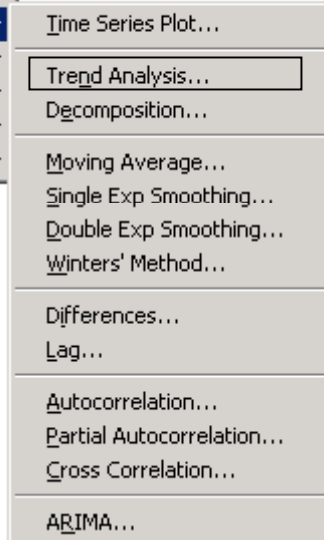
☐ Clock:

**Data display:**

Item	Display	For each	Group variables
1	Symbol	Graph	
2	Connect	Graph	
3			



# EXAMPLE – STOCKS



**Trend Analysis**

Variable:

**Model Type**

☐ Linear

☒ Quadratic

☐ Exponential growth

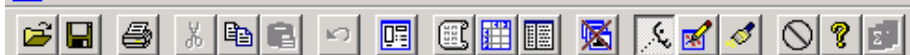
☐ S-Curve (Pearl-Reed logistic)

☒ Generate forecasts

Number of forecasts:

Starting from origin:

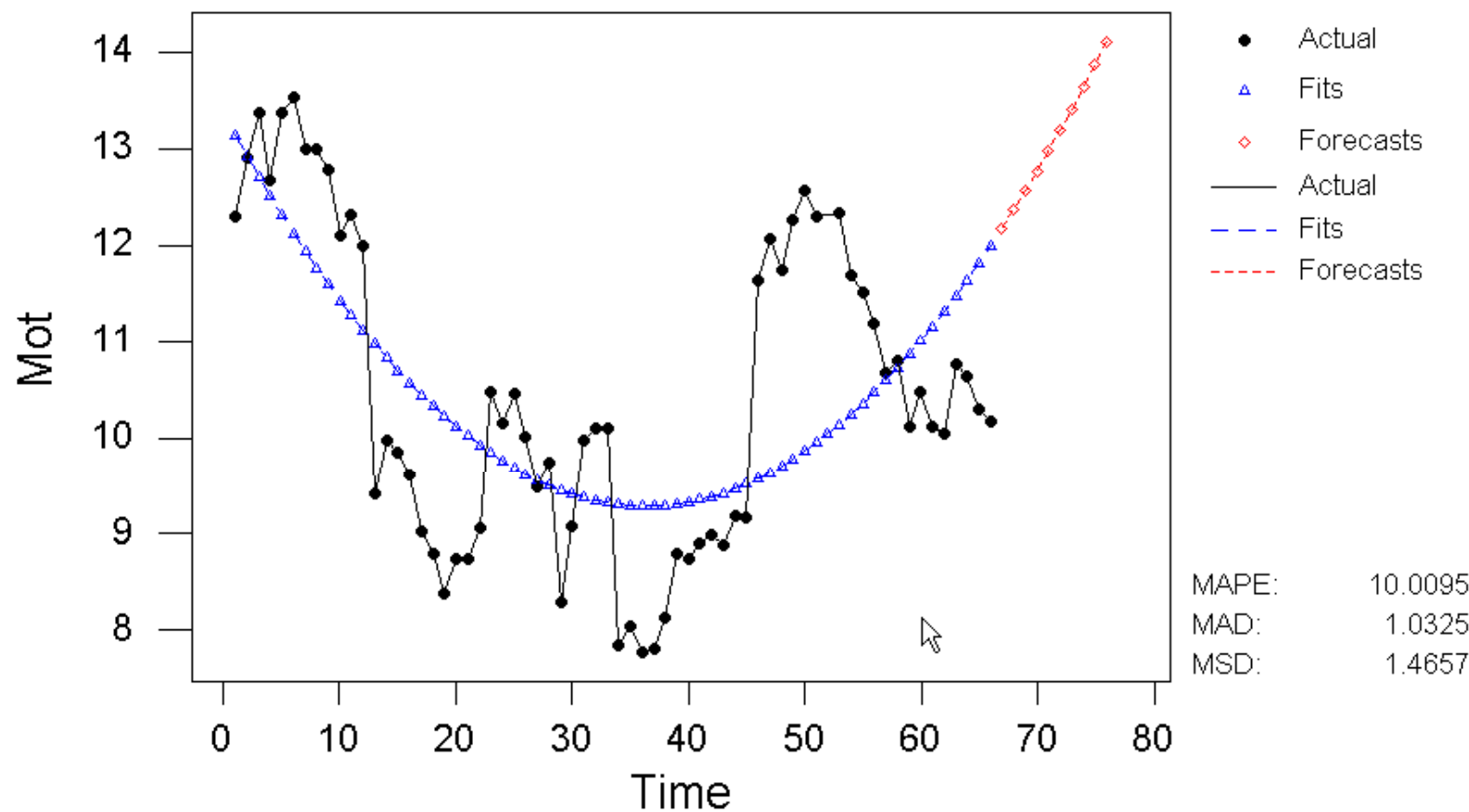
Title:



# Trend Analysis for Mot

Quadratic Trend Model

$$Y_t = 13.3557 - 0.223221 \cdot t + 3.07 \text{E-}03 \cdot t^{**}2$$



Stat Graph Editor Window

Basic Statistics ▶  
Regression ▶  
ANOVA ▶  
DOE ▶  
Control Charts ▶  
Quality Tools ▶  
Reliability/Survival ▶  
Multivariate ▶  
Time Series ▶  
Tables ▶  
Nonparametrics ▶  
EDA ▶  
Power and Sample Size ▶

Time Series Plot...

Trend Analysis...

Decomposition... ←

Moving Average...

Single Exp Smoothing...

Double Exp Smoothing...

Winters' Method...

Differences...

Lag...

Autocorrelation...

Partial Autocorrelation...

Cross Correlation...

ARIMA...

### Decomposition

Variable: Mot

Seasonal length: 15

#### Model Type

☒ Multiplicative

☐ Additive

#### Model Components

☒ Trend plus seasonal

☐ Seasonal only

First obs. is in seasonal period:

1

☒ Generate forecasts

Number of forecasts:

10

Starting from origin:

Title:

Select

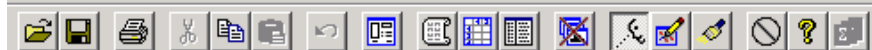
Results...

Storage...

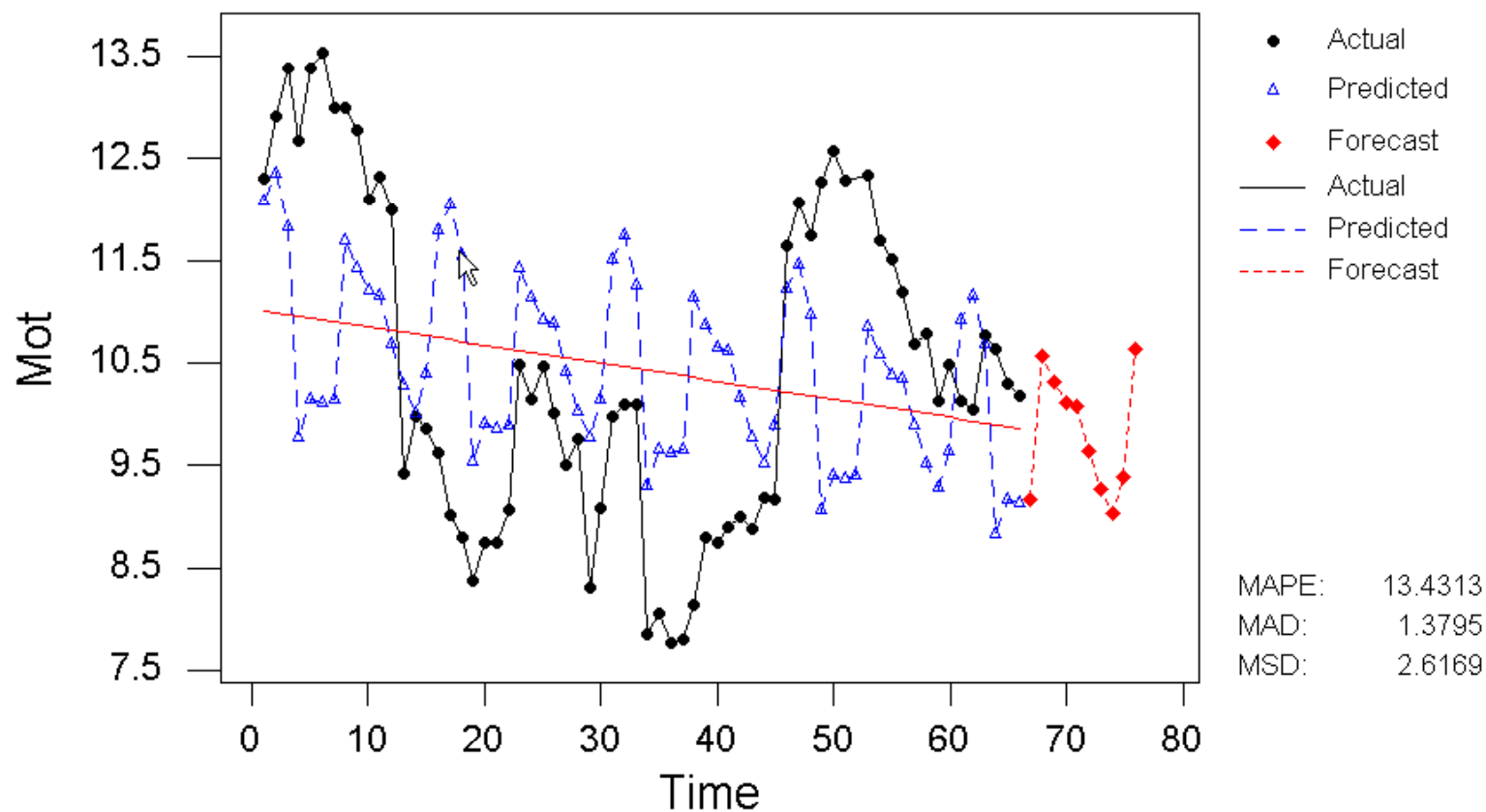
Help

OK

Cancel



## Decomposition Fit for Mot

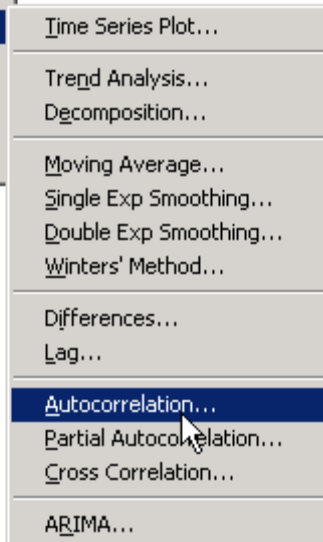




# Autocorrelation

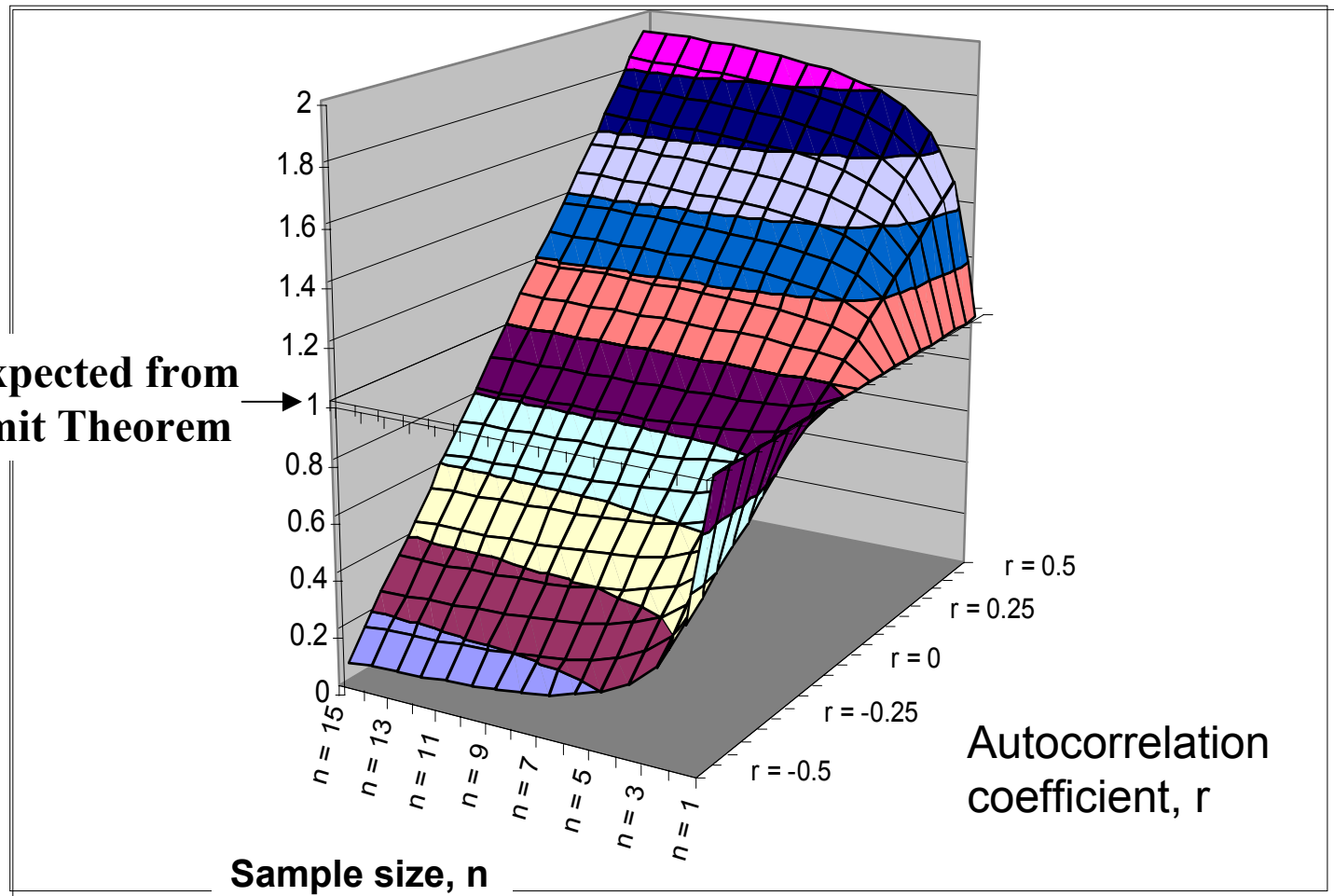


The autocorrelation correlogram shows the correlation between values that vary over time, with varying lags.

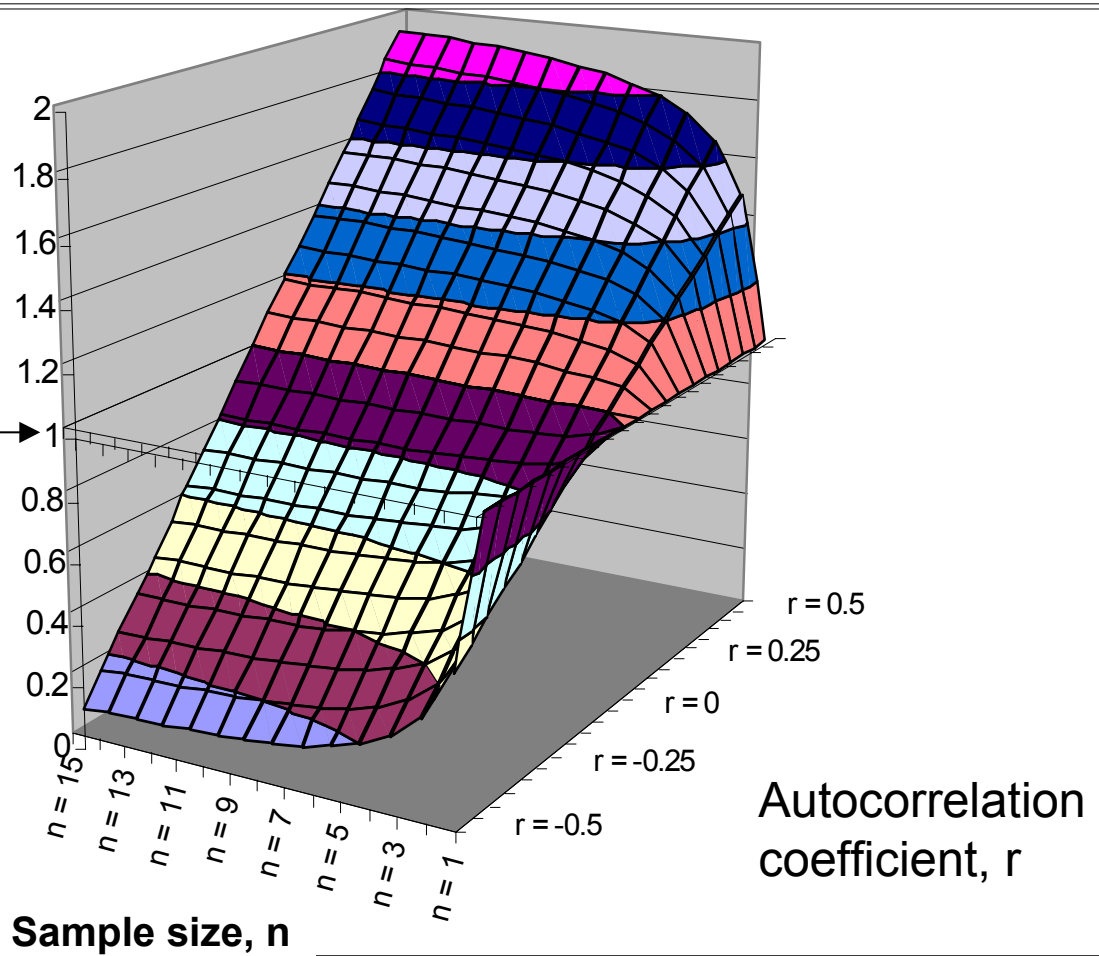


Autocorrelation of lag 1 is the correlation of each observation with the prior observation. The Central Limit Theorem assumes independence, which relates to zero autocorrelation. If there is autocorrelation,  $\text{variance}(\bar{y}) = C\sigma^2/n = C * (\text{variance of means from C.L.T.})$ .  $C$  is the ratio of observed variance of means to that expected from the Central Limit Theorem.  $C$  can range from 0 to 2, depending on the autocorrelation and the sample size. The autocorrelation for lag of 1 can range from  $-0.5$  to  $+0.5$ .

**Variance expected from Central Limit Theorem** →



**Variance expected from  
Central Limit Theorem**



# **O**VERVIEW

## **D**ATA VS. **T**IME

- Complications of S.P.C. in Semiconductor Processing
- Identifying and Prioritizing Critical Parameters
- Gauge Capability
- Levels of Variation
- Control Charting
- Times Series Modeling

# COMPLICATIONS OF S.P.C. IN SEMICONDUCTOR PROCESSING

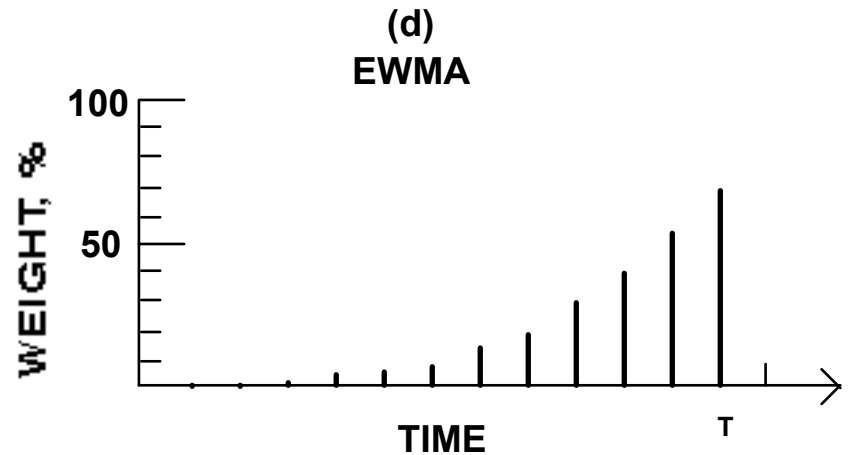
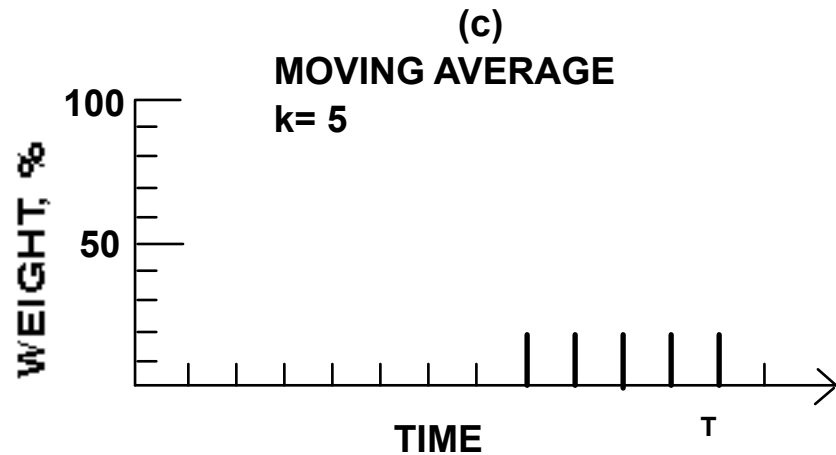
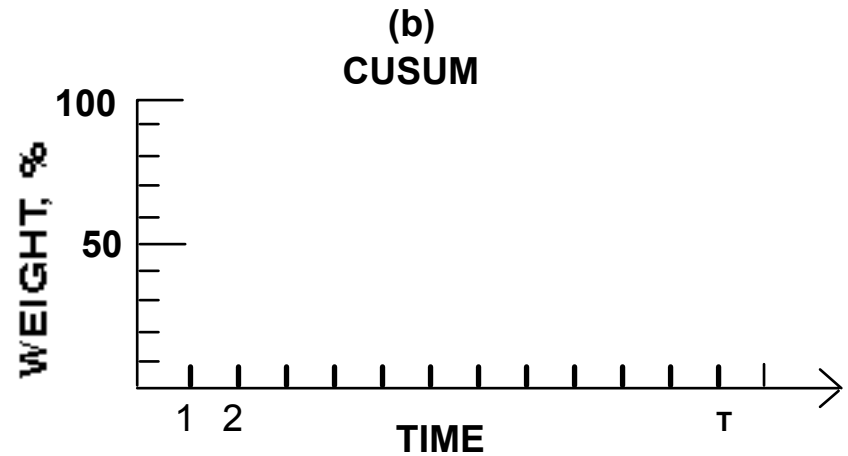
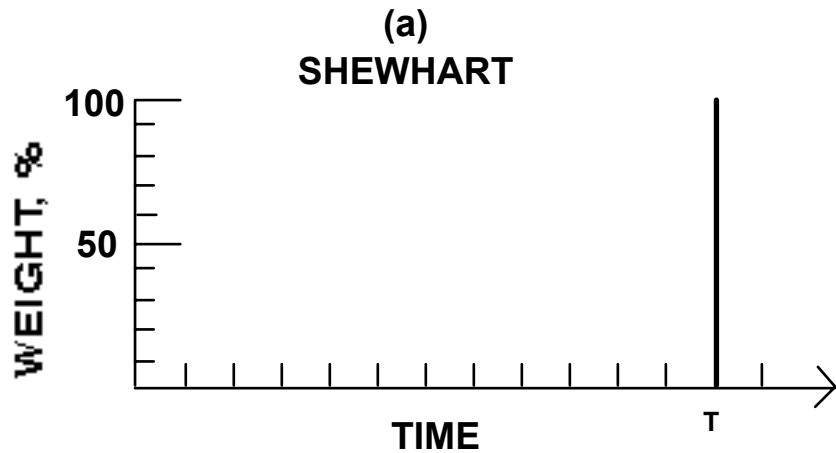
## 1. Indirect relationship of process parameters to device performance

- Most IC fabrication operations involve chemical inputs and outputs, that relate indirectly to device performance (electrical outputs)
- Effects on SPC - in many cases, spec limits were set somewhat arbitrarily (that is, not based upon the effect on device performance)

## 2. Quantity of process operations, input and output parameters

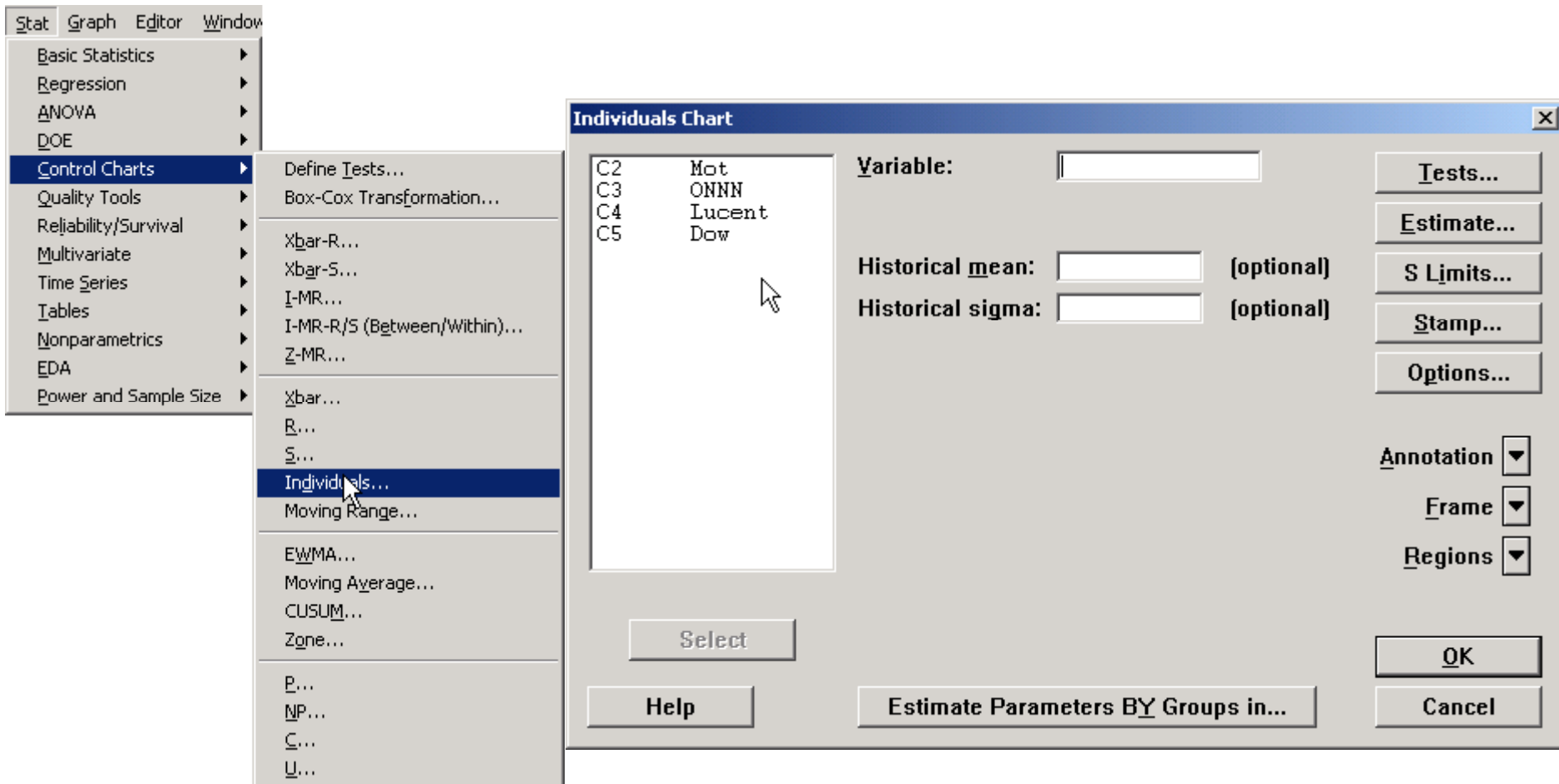
- There are literally hundreds or thousands of process parameters (input and output) that can effect the product
- Effects on SPC - there are insufficient resources to completely characterize each parameter

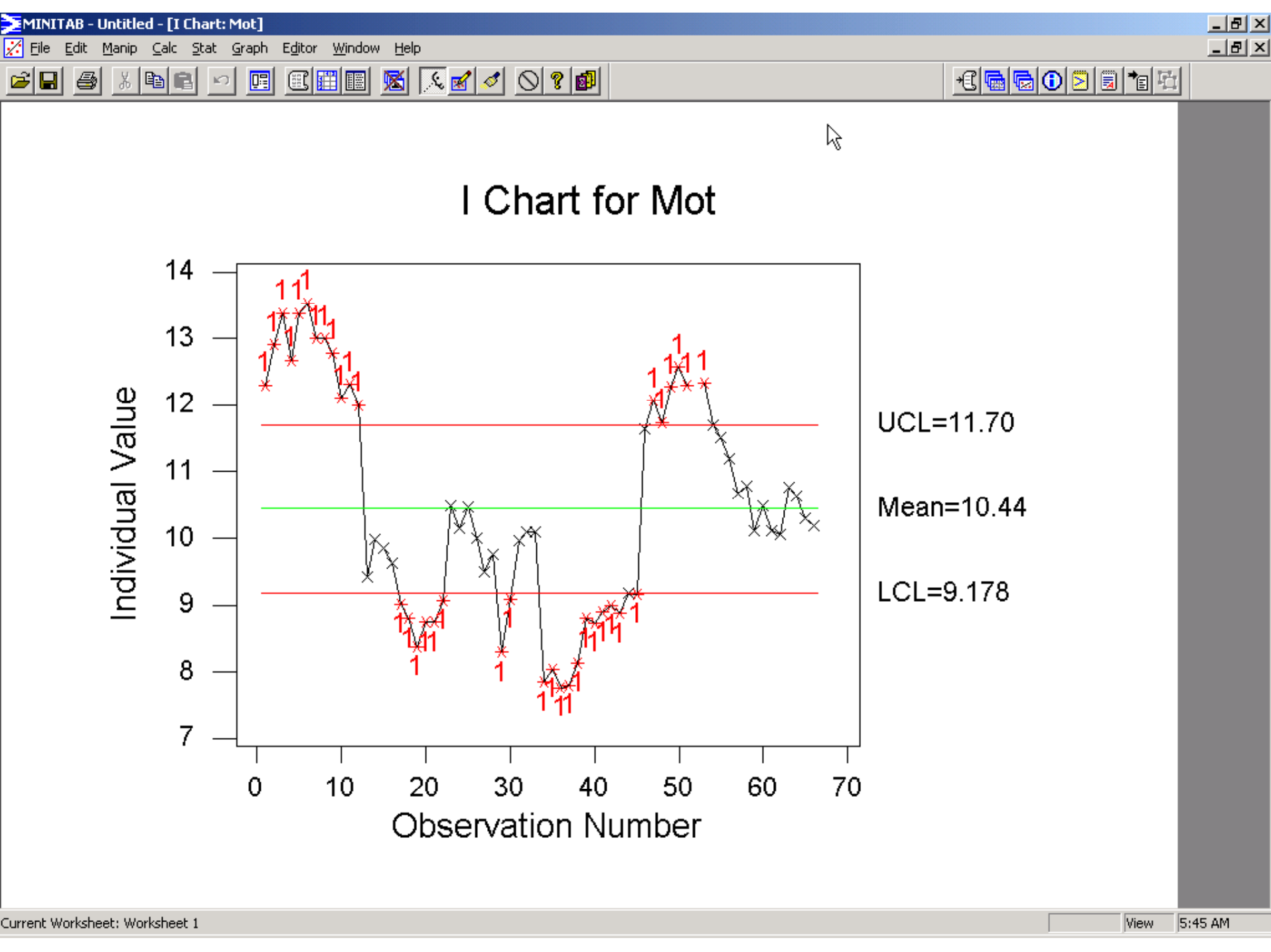
# THE EXPONENTIALLY WEIGHTED MOVING AVERAGE



# SPC – Individuals Chart

(Applied to stock prices...)







# SPC is an ongoing Statistical Test

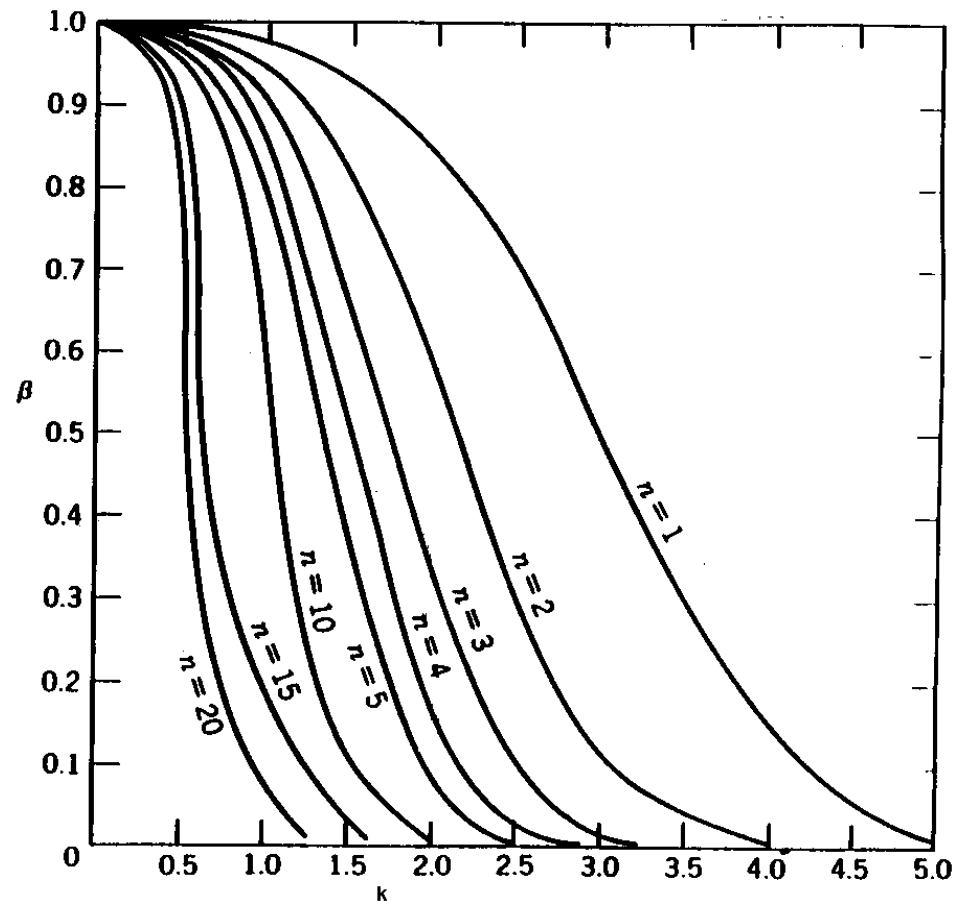
## RISKS

## REALITY

YOUR CONCLUSION

		There <u>is</u> a difference	There is <u>not</u> a difference
YOUR CONCLUSION	There <u>is</u> a difference	(WAY TO GO!!!)	$\alpha$ - RISK (TYPE I ERROR)
	There is <u>not</u> a difference	$\beta$ - RISK (TYPE II ERROR)	(WAY TO GO!!!)

# BETA RISK FOR $\bar{X}$ CONTROL CHART



Operating characteristic curves for the  $\bar{x}$  chart with 3-sigma limits.  $\beta = p$  (not detecting a shift of  $k\sigma$  in the mean on the first sample following the shift).

Note: Over time, the beta risk decreases.



# SPC – EWMA Chart

**EWMA Chart**

C2	Mot
C3	ONNN
C4	Lucent
C5	Dow

Data are arranged as

☒ **Single column:**

**Subgroup size:**   
(use a constant or an ID column)

☐ **Subgroups across rows of:**

**Weight for EWMA:**

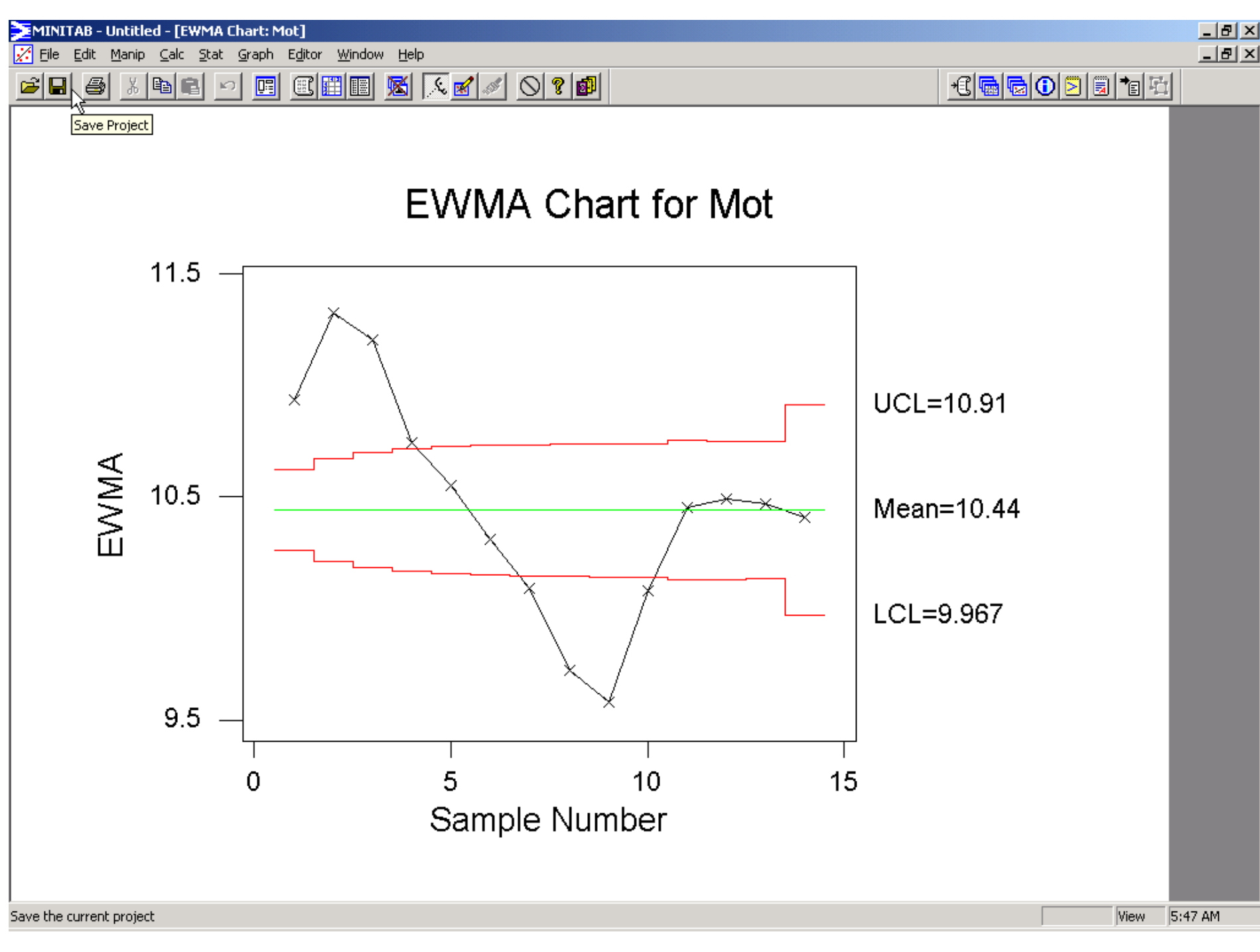
**Historical mean:**  [optional]

**Historical sigma:**  [optional]

**Annotation** ▼

**Frame** ▼

**Regions** ▼



# COMPLICATIONS OF S.P.C. IN SEMICONDUCTOR PROCESSING

## 3. Nested variance

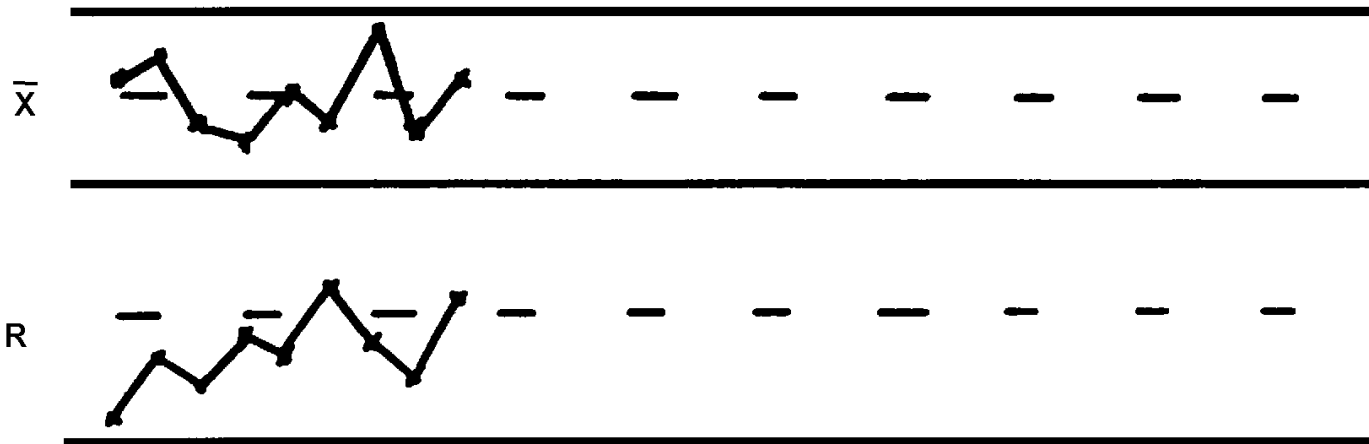
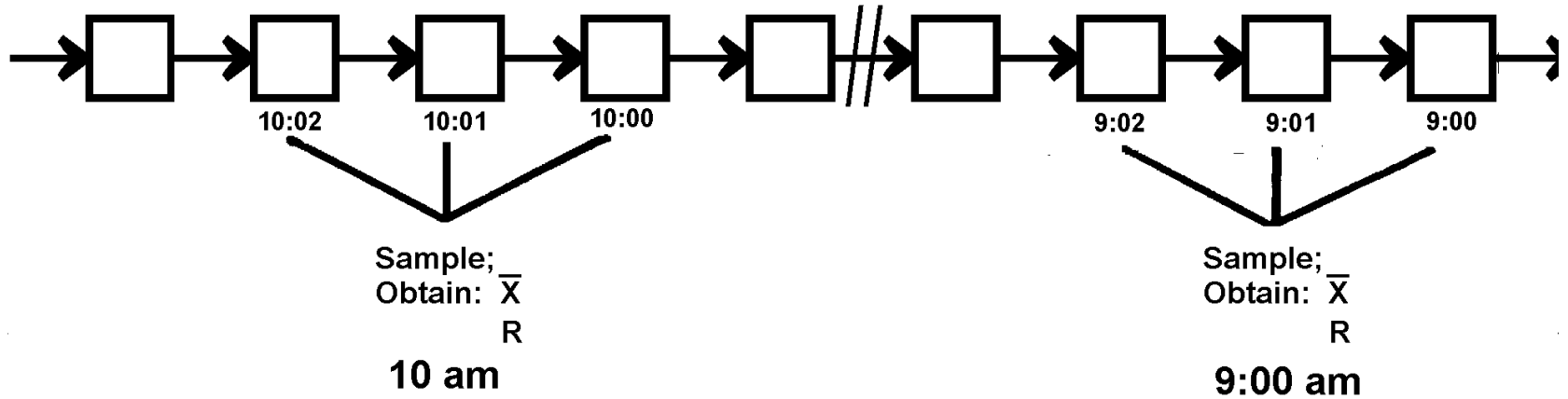
- There are at least three levels of variation (lot-lot, wafer–wafer, within–wafer)
- Effects on SPC - requirement to control multiple levels of variation; complications in establishing control limits. (Advantage: can provide clues to cause of out–of–control condition; can use to establish response procedures)

## 4. Non-normal distributions

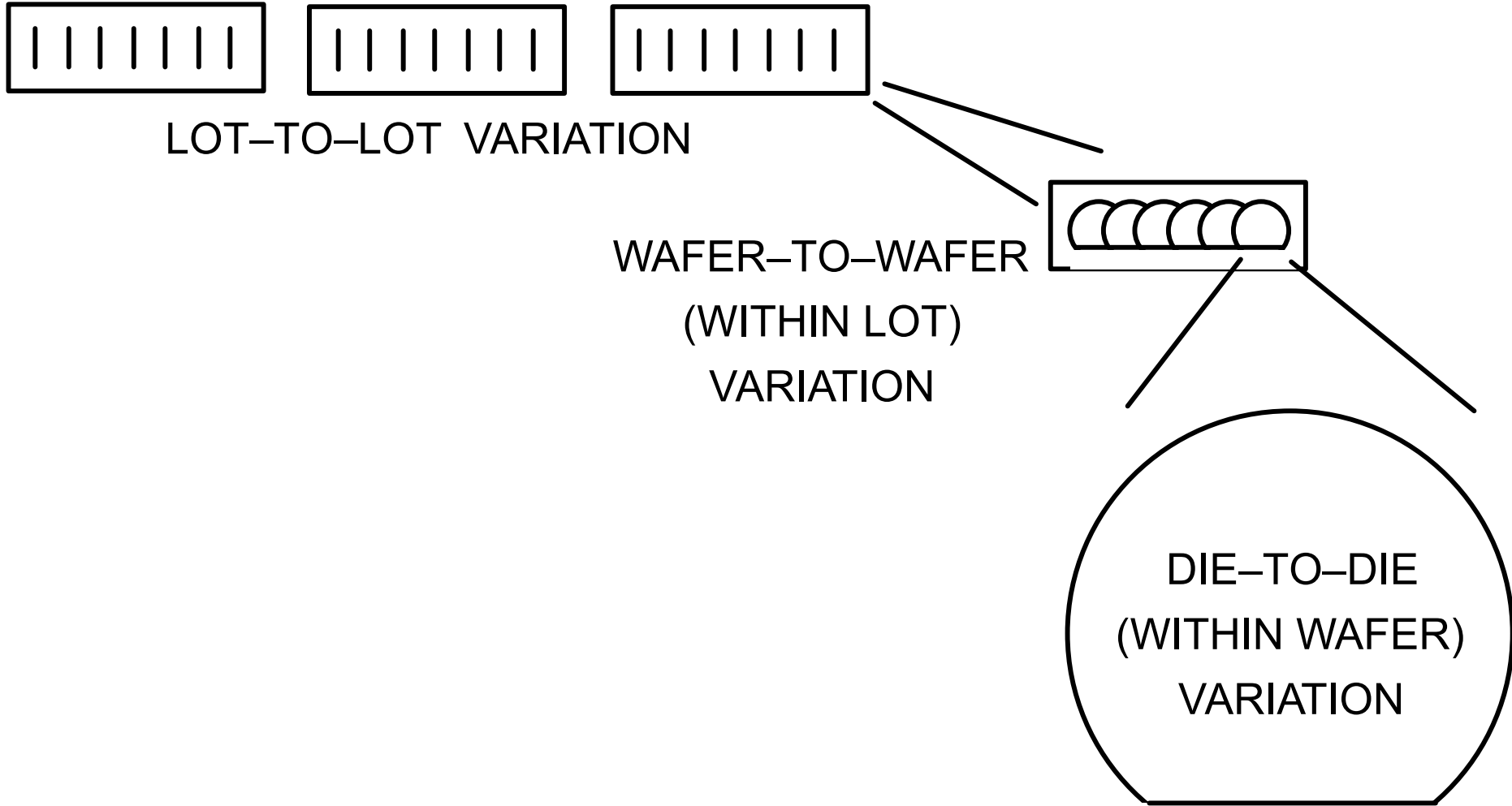
- Several key parameters have non-normal distributions (examples: HFE, contact resistance, sheet resistance)
- Effects on SPC - "X-bar" (lot means) may not approach normality (central limit theorem), because lot-lot is often the only level of variation with respect to time

# SHEWHART CONTROL CHART MODEL

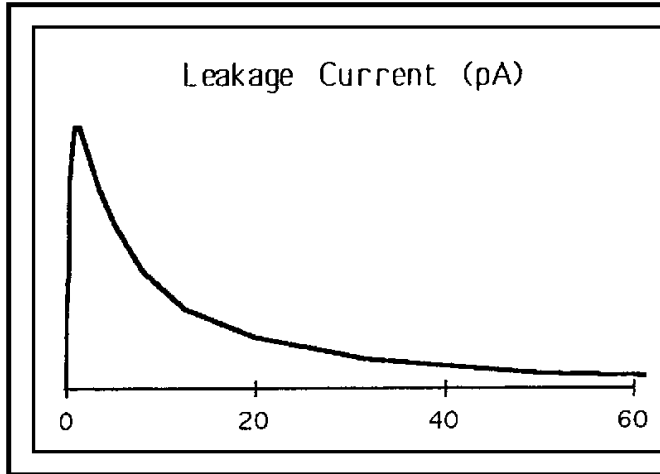
## Assembly Line:



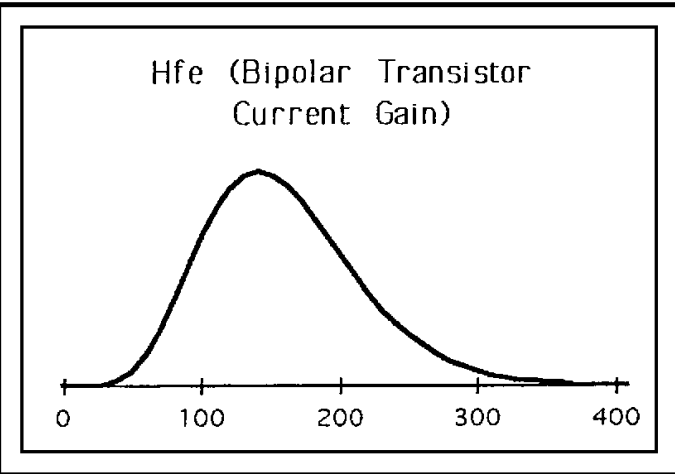
# NESTED VARIANCE IN I.C. MANUFACTURING:



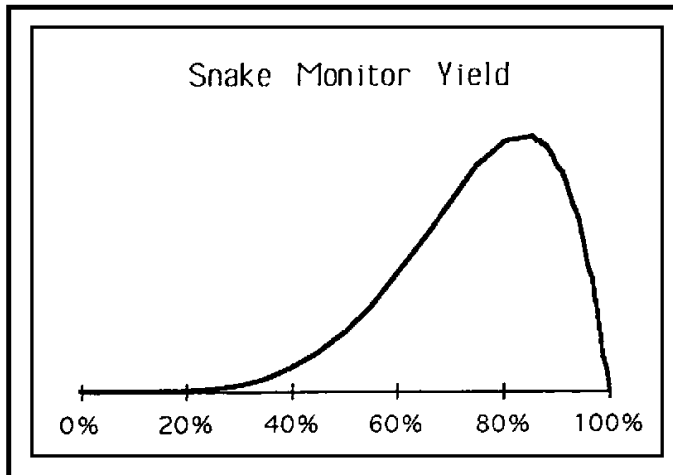
# NON-NORMAL DISTRIBUTION IN SEMICONDUCTOR PROCESSING



LOG-NORMAL DISTRIBUTION



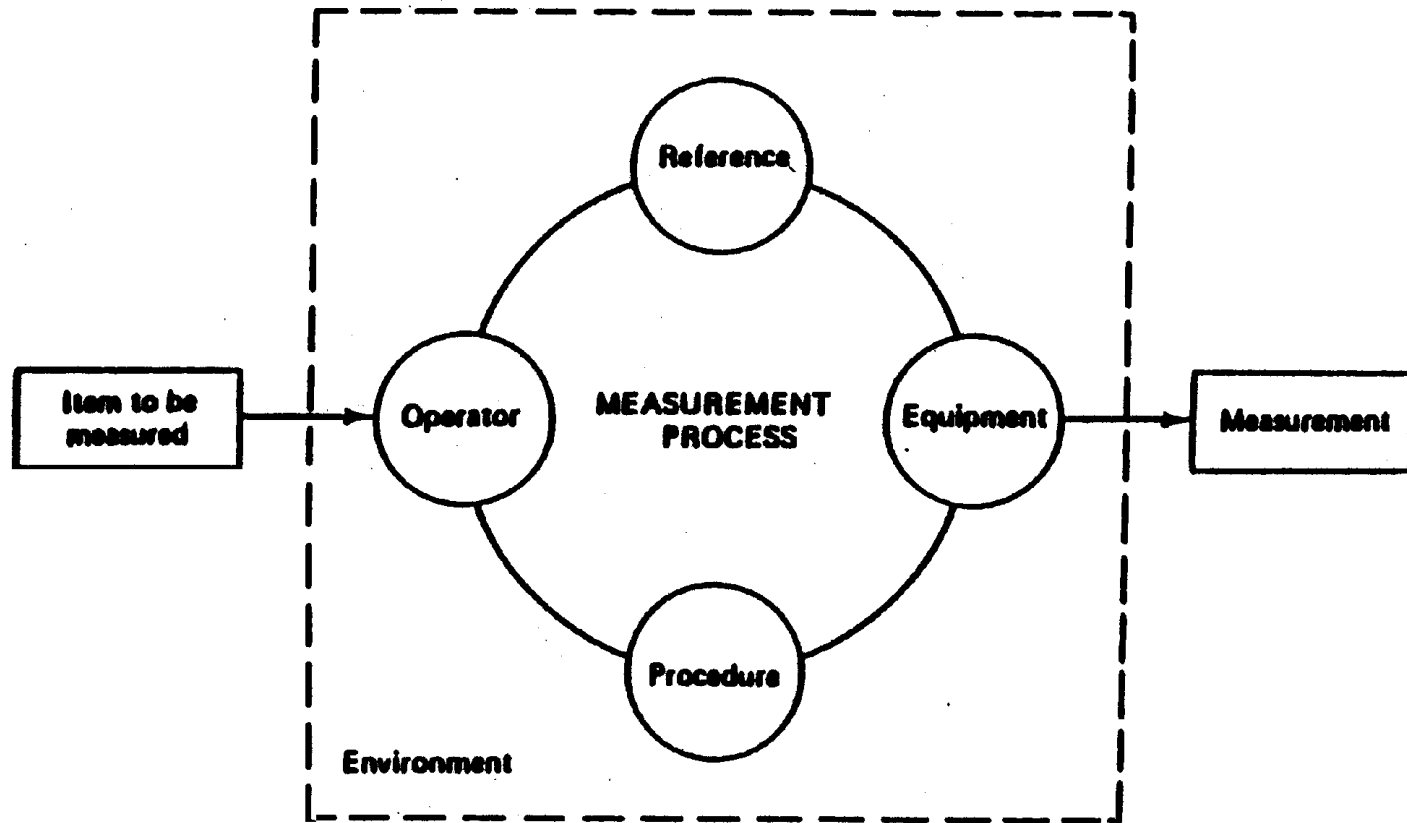
GAMMA DISTRIBUTION



BETA DISTRIBUTION



# MEASUREMENT AS A PRODUCTION PROCESS CONCEPT



# **A**CCURACY AND **P**RECISION

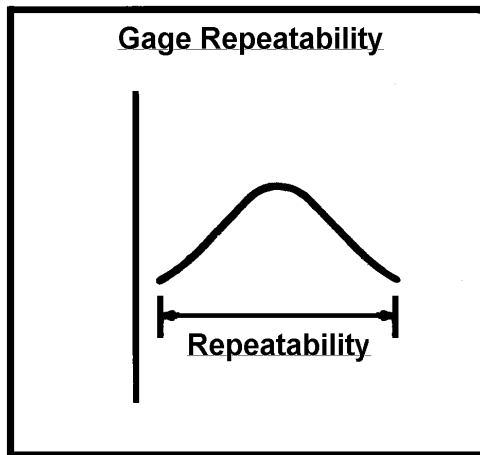
Accuracy = Closeness to the truth

Precision = Closeness of replicate measurements

# PRECISION:

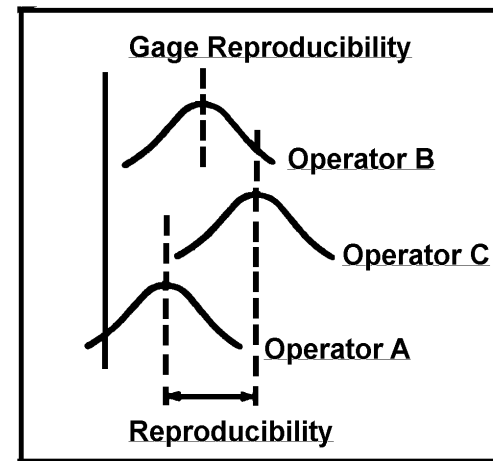
## REPEATABILITY AND REPRODUCIBILITY

Precision — The degree of agreement among individual measurements of the same sample



Gage Repeatability

Gage Repeatability is the variation in measurements obtained when one operator uses the same gage for measuring the identical characteristics of the same parts.



Gage Reproducibility

Gage Reproducibility is the variation in the average of measurements made by different operators using the same gage when measuring identical characteristics of the same parts.

# PRECISION/TOLERANCE RATIO

## P/T RATIO

The P/T value is the ratio between the measurement precision estimate and the tolerance of the characteristic being measured.

$$\text{P/T Ratio} = \frac{6 \sigma_E}{\text{Total Tolerance}}$$

Where  $\sigma_E$  is the standard deviation due to measurement variability.

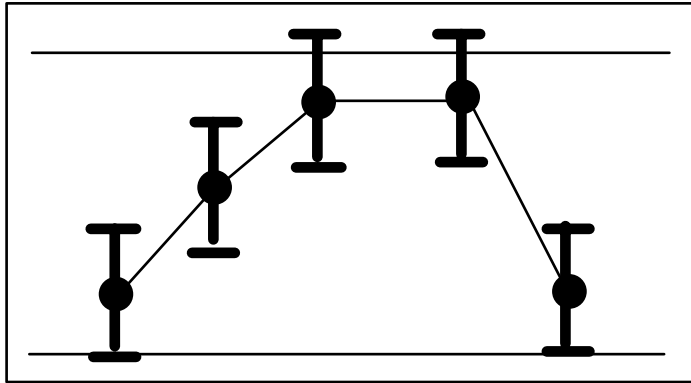
Assumption:

Measurement errors are independent

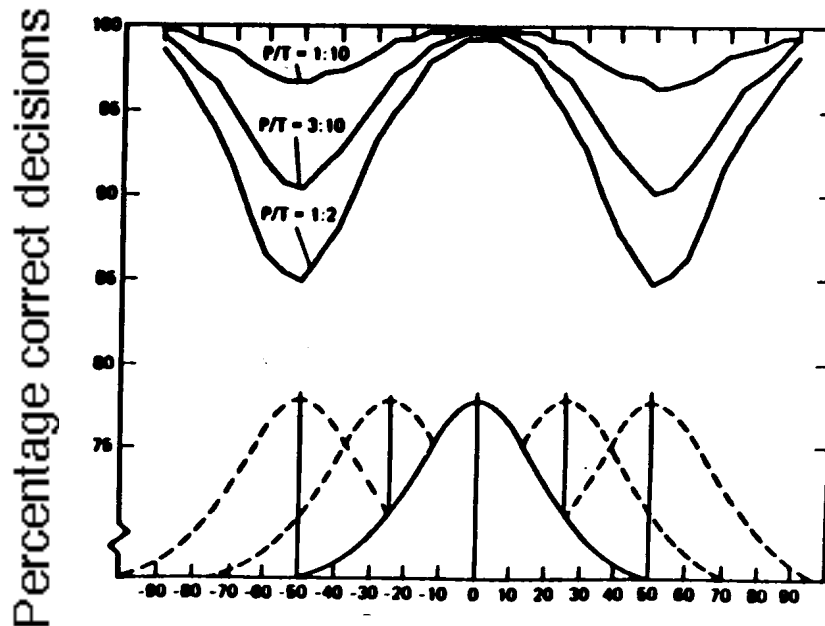
Measurement errors are normally distributed

Measurement error is independent of part size

# EFFECT OF P/T RATIO ON DECISION MAKING



Control chart with measurement error.



Position of parts distribution where  
60 parts = total tolerance  
scale units = percentage from aim



The 'Gage R&R Study (Crossed)' dialog box is shown. It contains fields for 'Part numbers', 'Operators', and 'Measurement data'. The 'Method of Analysis' section has two radio buttons: 'ANOVA' (selected) and 'Xbar and R'. There are 'Select', 'Help', 'Gage Info...', 'Options...', 'OK', and 'Cancel' buttons.

**Gage R&R Study (Crossed)**

Source	Part numbers	Operators	Measurement data
C1	Part number		
C2	Operator name		
C3	Measurement		

Method of Analysis

☒ ANOVA  
☐ Xbar and R

Buttons: Select, Help, Gage Info..., Options..., OK, Cancel

The 'Gage R&R Study (Crossed) - Gage Info' dialog box is shown. It contains fields for 'Gage name', 'Date of study', 'Reported by', 'Gage Tolerance', and 'Miscellaneous'. There are 'Help', 'OK', and 'Cancel' buttons.

**Gage R&R Study (Crossed) - Gage Info**

Gage name: Nanometrics

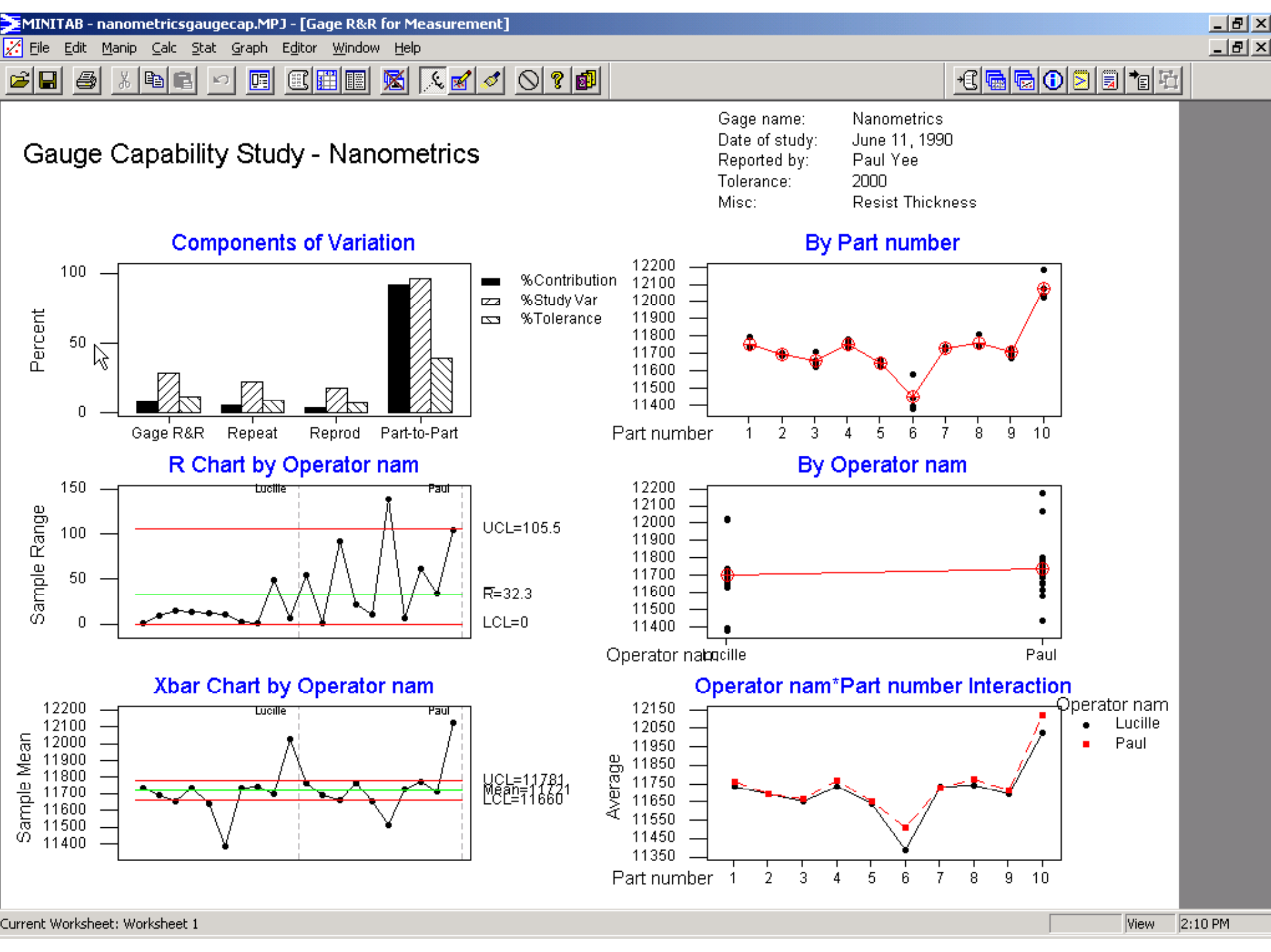
Date of study: June 11, 1990

Reported by: Paul Yee

Gage Tolerance: 2000

Miscellaneous: Resist Thickness

Buttons: Help, OK, Cancel



## Gage R&R Study - ANOVA Method

Gage R&R for Measurement

Gage name: Nanometrics  
Date of study: June 11, 1990  
Reported by: Paul Yee  
Tolerance: 2000  
Misc: Resist Thickness

### Two -Way ANOVA Table With Interaction

Source	DF	SS	MS	F	P
Part number	9	858523	95391.5	50.6934	0.00000
Operator nam	1	12461	12460.9	6.6220	0.03002
Operator nam*Part number	9	16936	1881.7	1.4865	0.21961
Repeatability	20	25318	1265.9		
Total	39	913238			

### Gage R&R

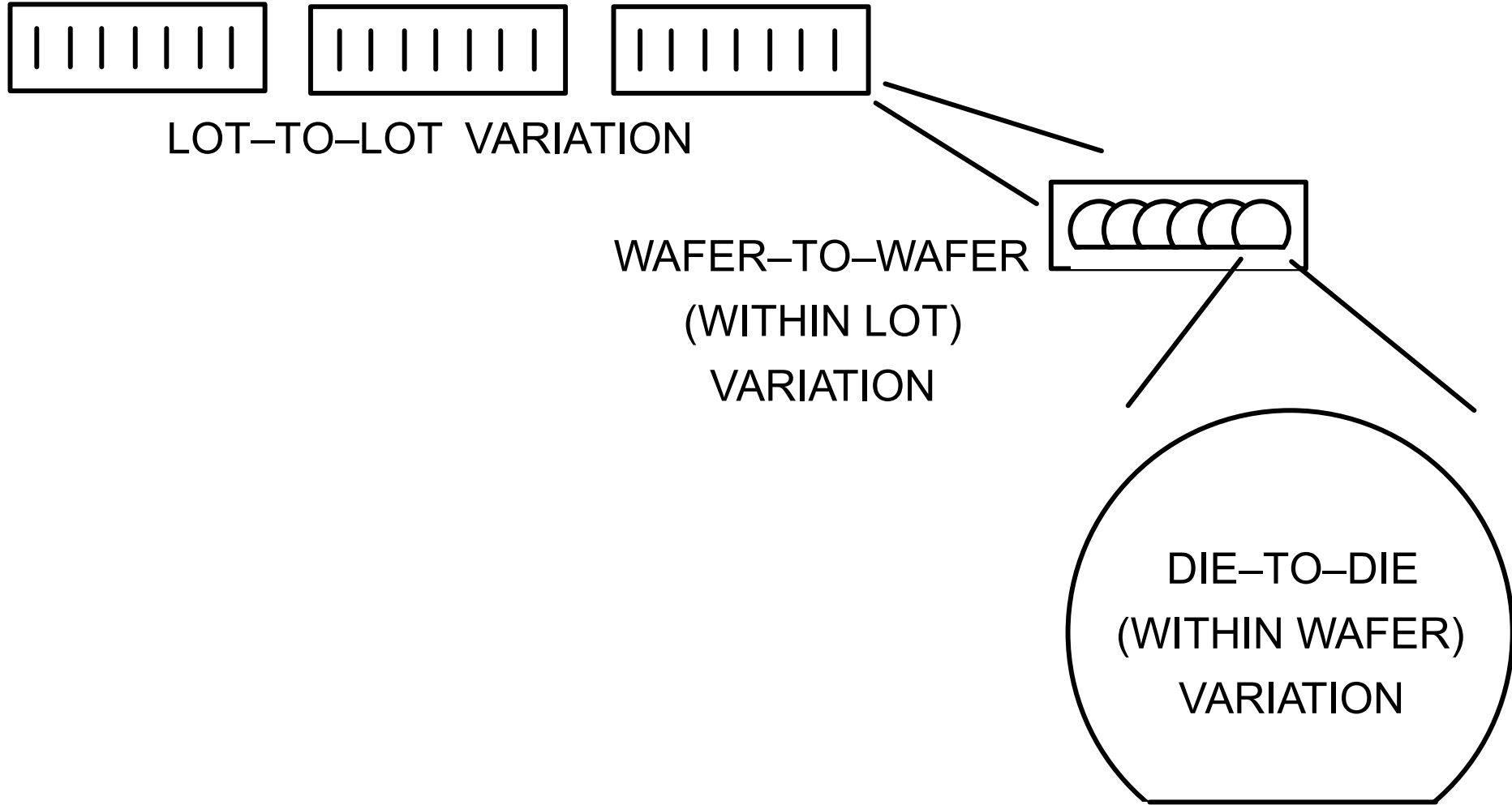
Source	VarComp	%Contribution (of VarComp)
Total Gage R&R	2103	8.25
Repeatability	1266	4.97
Reproducibility	837	3.28
Operator nam	529	2.08
Operator nam*Part number	308	1.21
Part - To - Part	23377	91.75
Total Variation	25480	100.00

Source	StdDev (SD)	Study Var (5.15*SD)	%Study Var (%SV)	%Tolerance (SV/Toler)
Total Gage R&R	45.856	236.159	28.73	11.81
Repeatability	35.579	183.234	22.29	9.16
Reproducibility	28.929	148.983	18.12	7.45
Operator nam	22.999	118.445	14.41	5.92
Operator nam*Part number	17.548	90.370	10.99	4.52
Part - To - Part	152.897	787.419	95.78	39.37
Total Variation	159.625	822.070	100.00	41.10

Number of Distinct Categories = 5



# NESTED VARIANCE IN I.C. MANUFACTURING:



- Stat
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- Power and Sample Size

- Run Chart...
- Pareto Chart...
- Cause-and-Effect...
- Capability Analysis (Normal)...
- Capability Analysis (Between/Within)...
- Capability Analysis (Weibull)...
- Capability Sixpack (Normal)...
- Capability Sixpack (Between/Within)...
- Capability Sixpack (Weibull)...
- Capability Analysis (Binomial)...
- Capability Analysis (Poisson)...
- Gage Run Chart...
- Gage Linearity Study...
- Gage R&R Study (Crossed)...
- Gage R&R Study (Nested)...
- Attribute Gage R&R Study
- Multi-Vari Chart...
- Symmetry Plot...

### Multi-Vari Chart

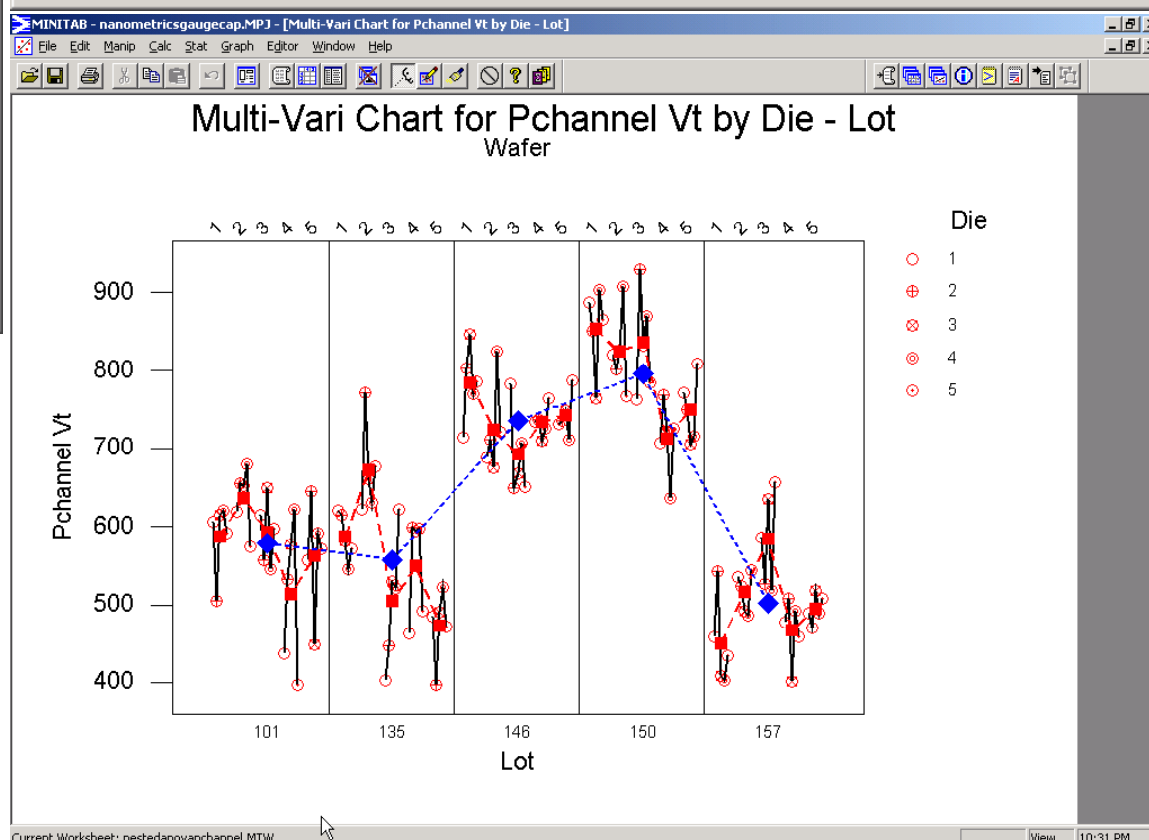
C1 Lot	Response: 'Pchannel Vt'	Options...
C2 Wafer	Factor 1: Die	
C3 Die	Factor 2: Wafer	
C4 Pchannel Vt	Factor 3: Lot	
	Factor 4:	

Select

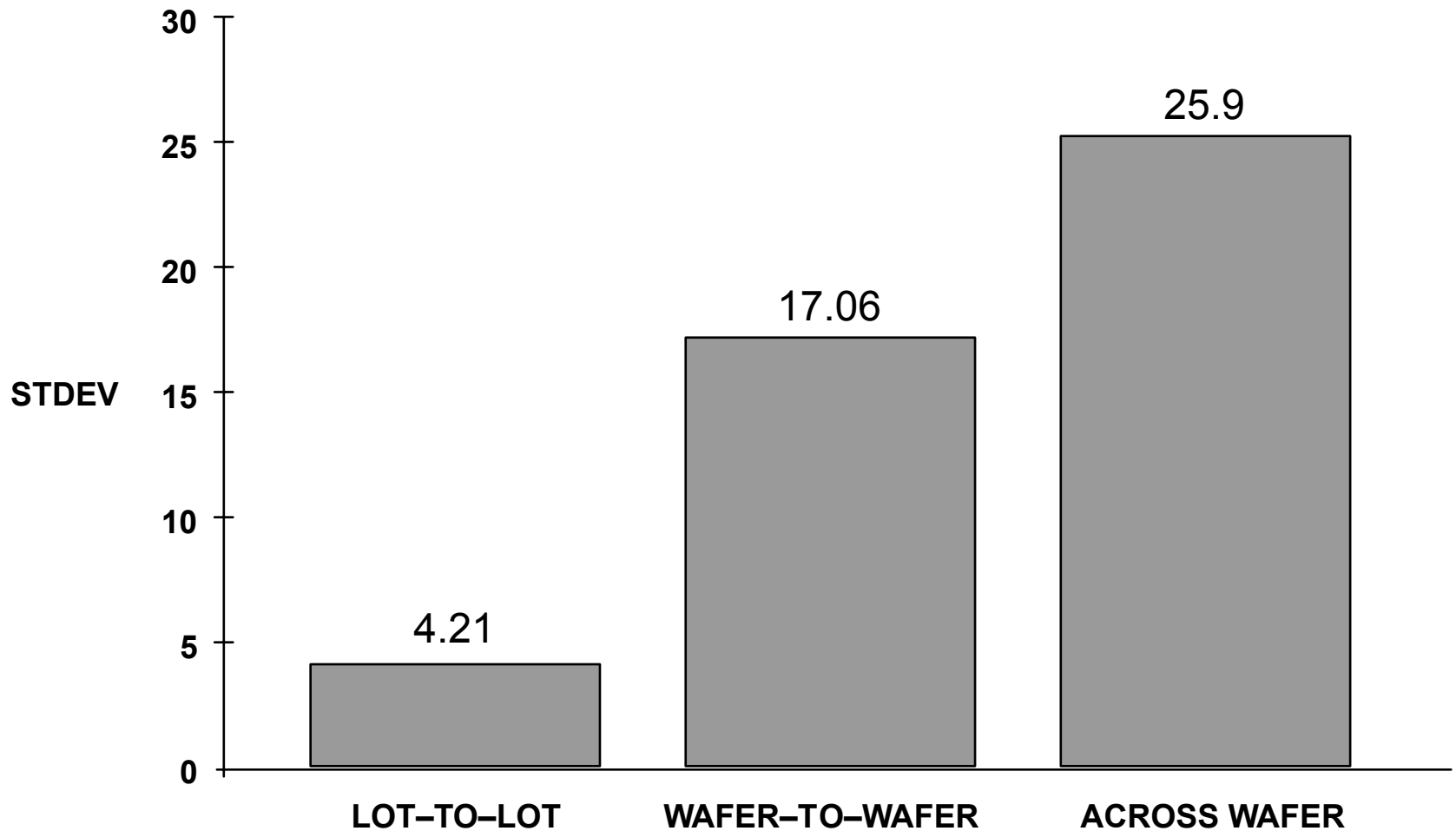
Help

OK

Cancel



# 63W H<sub>FE</sub> VARIANCE COMPONENTS ANALYSIS



# VARIANCE COMPONENTS ANALYSIS

## DIE-TO-DIE VARIANCE:

**DIE-TO-DIE VARIANCE = AVERAGE (VARIANCE ACROSS EACH WAFER)**

## WAFER-TO-WAFER VARIANCE:

If measurements on the same wafer are averaged repeatedly,  
Variance of means = (Die-to-die variance) /  $N_d$  (Center Limit Theorem)

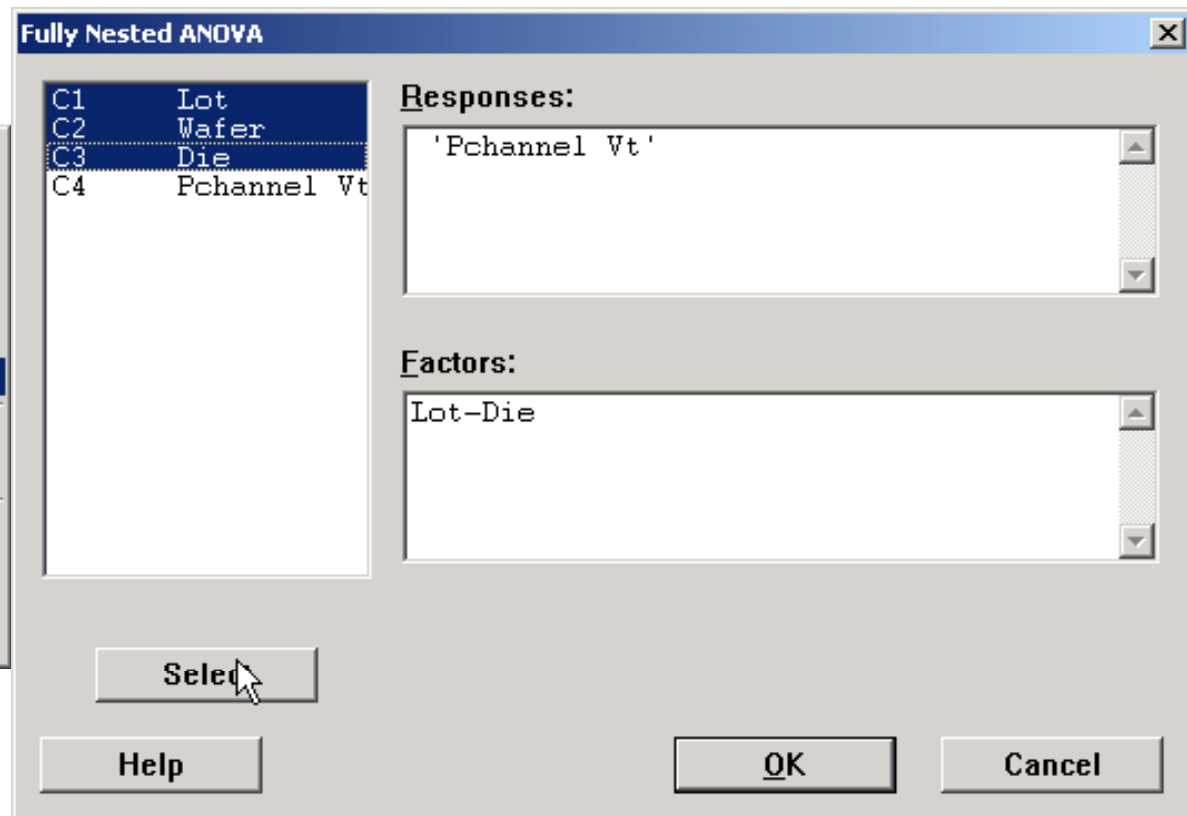
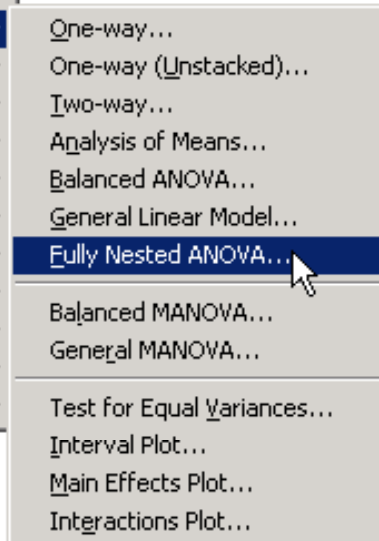
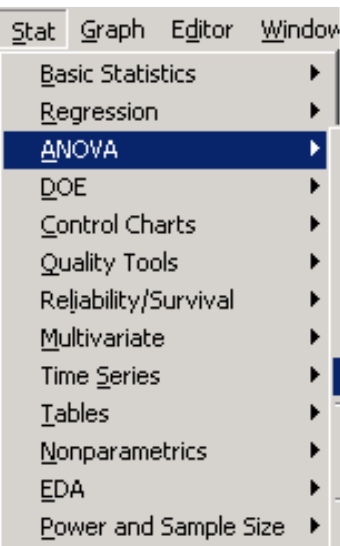
**Wafer-To-Wafer Variance = (Average of the variances of wafer means)  
– (Die-to-die variance) /  $N_d$**

## LOT-TO-LOT VARIANCE:

**Lot-to-lot Variance = (Variance of lot means)  
– (Average of the variances of wafer means) /  $N_w$**

**TOTAL VARIANCE = DIE-TO-DIE VARIANCE  
+ WAFER-TO-WAFER VARIANCE  
+ LOT-TO-LOT VARIANCE**

# NESTED ANALYSIS OF VARIANCE— MINITAB EXAMPLE



## Nested ANOVA: Pchannel Vt versus Lot, Wafer, Die

Analysis of Variance for Pchannel

Source	DF	SS	MS	F	P
Lot	4	1568342.4642	392085.6160	25.071	0.000
Wafer	20	312782.2958	15639.1148	5.407	0.000
Die	100	289251.9864	2892.5199		
Total	124	2170376.7464			

Variance Components

Source	Var Comp.	% of Total	StDev
Lot	15057.860	73.45	122.710
Wafer	2549.319	12.44	50.491
Die	2892.520	14.11	53.782
Total	20499.699		143.177